# 2SD1198, 2SD1198A

## Silicon NPN epitaxial planar type darlington

### For low-frequency amplification

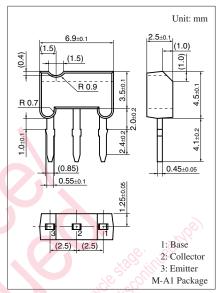
### ■ Features

- Forward current transfer ratio  $h_{FE}$  is designed high, which is appropriate to the driver circuit of motors and printer hammer:  $h_{FE} = 4$
- A shunt resistor is omitted from the driver.
- M type package allowing easy automatic and manual insertion as well as stand-alone fixing to the printed circuit board.

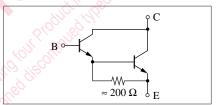
### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage	2SD1198	$V_{CBO}$	30	V
(Emitter open)	2SD1198A		60	
Collector-emitter voltage	2SD1198	$V_{CEO}$	25	V
(Base open)	2SD1198A		50	
Emitter-base voltage (Col	$V_{EBO}$	5	V	
Collector current	$I_{C}$	1	A	
Peak collector current	I <sub>CP</sub>	1.5	A	
Collector power dissipation	P <sub>C</sub>	1	W	
Junction temperature	$T_{j}$	150	°C	
Storage temperature	$T_{stg}$	-55 to +150	°C	

Note) \*: Printed circuit board: Copper foil area of 1 cm² or more, and the board thickness of 1.7 mm for the collector portion



#### Internal Connection



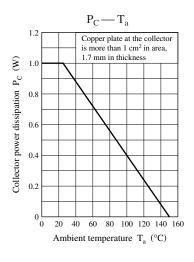
### ■ Electrical Characteristics $T_a = 25$ °C $\pm 3$ °C

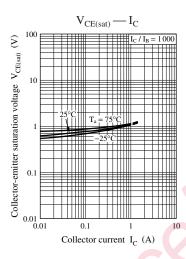
Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage	2SD1198	$V_{CBO}$	$I_C = 100 \mu\text{A}, I_E = 0$	30			V
(Emitter open)	2SD1198A		Ciec Wall	60			
Collector-emitter voltage	2SD1198	V <sub>CEO</sub>	$I_C = 1 \text{ mA}, I_B = 0$	25			V
(Base open)	2SD1198A	* SLOIL	S	50			
Emitter-base voltage (Colle	ctor open)	V <sub>EBO</sub>	$I_E = 100 \ \mu A, I_C = 0$	5			V
Collector-base cutoff current (E	mitter open)	$I_{CBO}$	$V_{CB} = 25 \text{ V}, I_{E} = 0$			100	nA
	6.		$V_{CB} = 45 \text{ V}, I_{E} = 0$				
Emitter-base cutoff current (Collector open)		$I_{EBO}$	$V_{EB} = 4 \text{ V}, I_{C} = 0$			100	nA
Forward current transfer rat	io *1, 2	h <sub>FE</sub>	$V_{CE} = 10 \text{ V}, I_{C} = 1 \text{ A}$	4000		20 000	_
Collector-emitter saturation	voltage *1	V <sub>CE(sat)</sub>	$I_C = 1 \text{ A}, I_B = 1 \text{ mA}$			1.8	V
Base-emitter saturation voltage *1		V <sub>BE(sat)</sub>	$I_C = 1 \text{ A}, I_B = 1 \text{ mA}$			2.2	V
Transition frequency		$f_T$	$V_{CB} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$		150		MHz

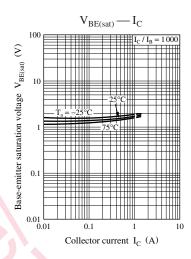
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

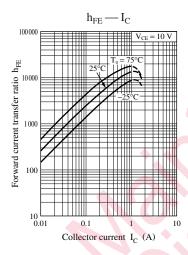
- 2. \*1: Pulse measurement
  - \*2: Rank classification

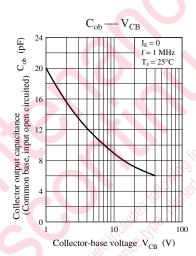
Rank	Q	R		
$h_{\mathrm{FE}}$	4000 to 10000	8 000 to 20 000		











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